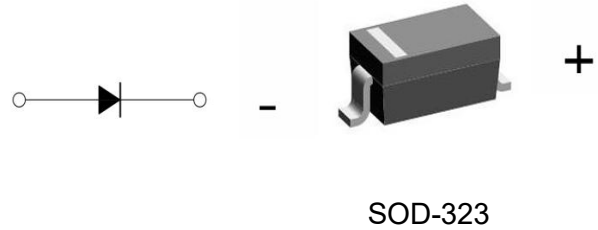


Schottky Barrier Diode

Parameter	Value	Unit
V_R	20~40	V
$I_{F(AV)}$	500	mA



Features

- Ultrafast Reverse Recovery Time
- Low Power Losses, High Efficiency
- Low Forward Voltage Drop
- High Surge Capability

Applications

- High-Frequency Inverters
- Switching Power Supply

Absolute Maximum Ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	B0520WS	B0530WS	B0540WS	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	V
Maximum RMS voltage	V_{RMS}	14	21	28	V
Maximum DC blocking voltage	V_{DC}	20	30	40	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	500			mA
Non-repetitive Peak Forward Surge Current @t=8.3ms Half-sine wave	I_{FSM}	5.5			A
Power Dissipation	P_D	200			mW
Junction temperature	T_J	-55-+125			°C
Storage temperature range	T_{STG}	-55-+150			°C
Typical thermal resistance	$R_{\theta JA}$	200			°C /W

Electrical Characteristics (Ta=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	B0520WS	B0530WS	B0540WS	Unit
Maximum forward voltage	V_{F1}	$I_F=0.1A$	0.33	0.375	-	V
	V_{F2}	$I_F=0.5A$	0.385	0.43	0.51	
	V_{F3}	$I_F=1.0A$	-	-	0.62	
Maximum reverse current	I_R	$V_R=10V$	0.075	-	-	mA
		$V_R=15V$	-	0.080	-	
		$V_R=20V$	0.25	-	0.01	
		$V_R=30V$	-	0.5	-	
		$V_R=40V$	-	-	0.02	
Capacitance between terminals	C_T	$V_R=0V, f=1MHz$	170			pF

Typical Characteristics

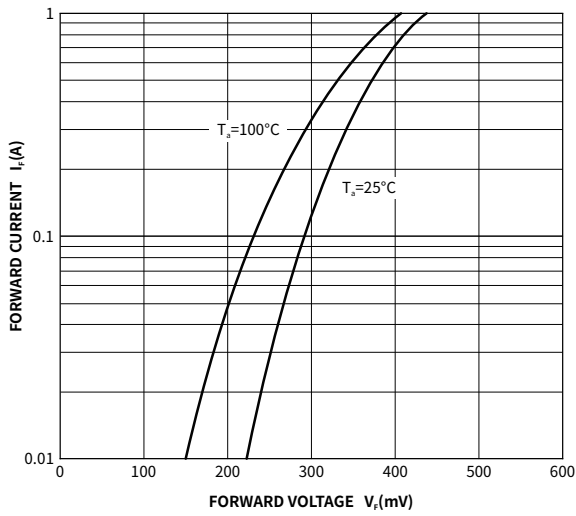


Fig.1 Typical Instantaneous Forward Characteristics

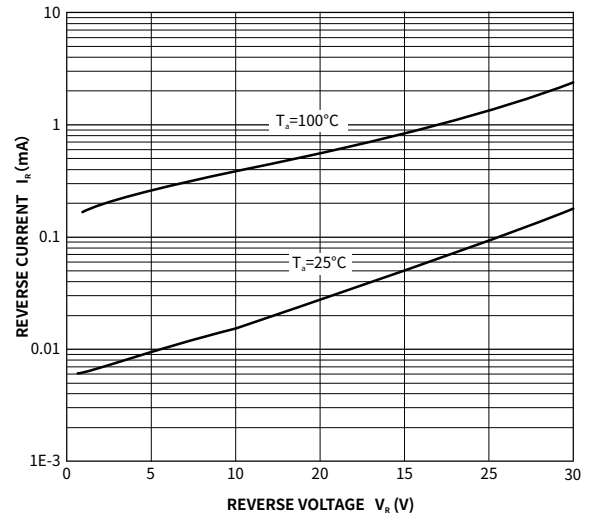


Fig.2 Typical Reverse Characteristics

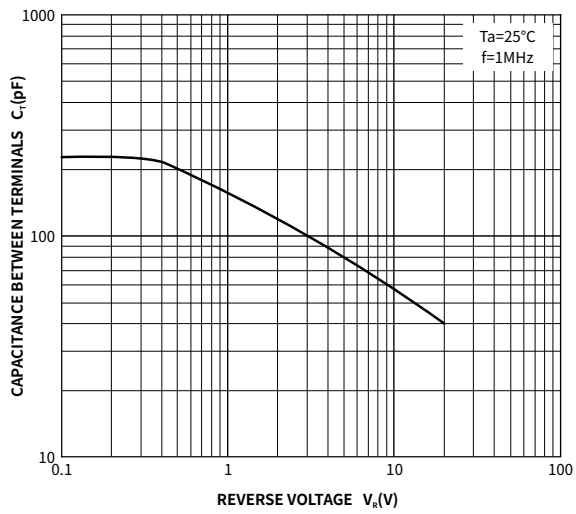


Fig.3 Typical Junction Capacitance

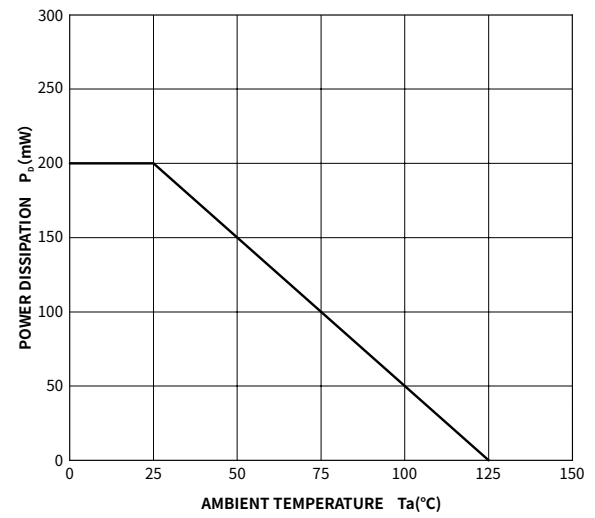
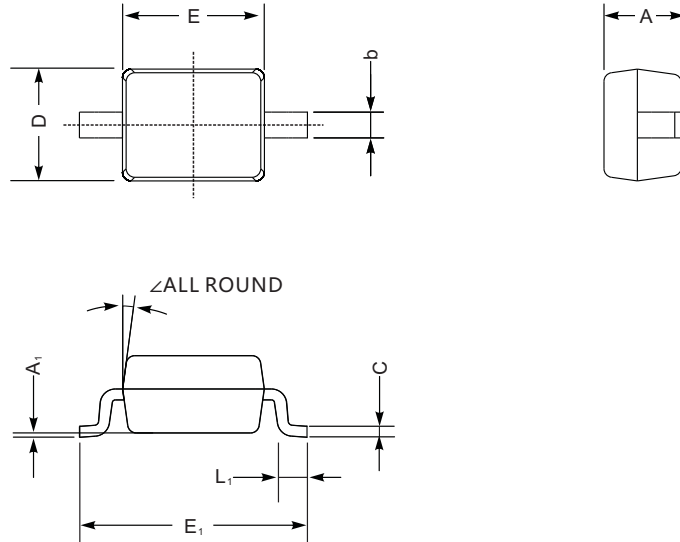


Fig.4 Power Derating Curve

Package Outlines (Units: mm)

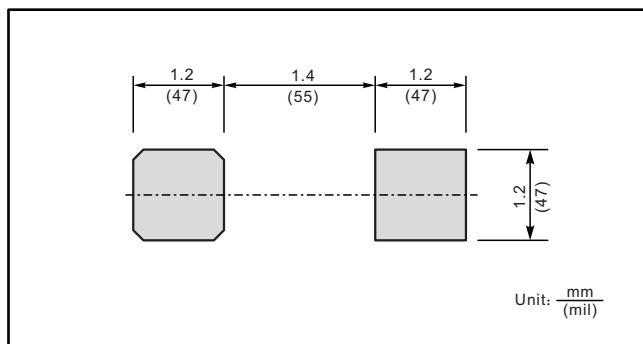
Plastic surface mounted package; 2 leads



SOD-323 mechanical data

UNIT		A	C	D	E	E ₁	b	L ₁	A ₁	∠
mm	max	1.1	0.15	1.4	1.8	2.75	0.4	0.45	0.2	9°
	min	0.8	0.08	1.2	1.4	2.55	0.25	0.2	—	
mil	max	43	5.9	55	70	108	16	16	8	
	min	32	3.1	47	63	100	9.8	7.9	—	

The recommended mounting pad size



Marking

Type number	Marking code
B0520WS	SD
B0530WS	SE
B0540WS	SF

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